Review

Direct Ink Writing Technology (3D Printing) of Graphene-Based Ceramic Nanocomposites: A Review

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Abstract: In the present work, the state of the art of the most common additive manufacturing (AM) technologies used for the manufacturing of complex shape structures of graphene-based ceramic nanocomposites, ceramic and graphene-based parts is explained. A brief overview of the AM processes for ceramic, which are grouped by the type of feedstock used in each technology, is presented. The main technical factors that affect the quality of the final product were reviewed. The AM processes used for 3D printing of graphene-based materials are described in more detail; moreover, some studies in a wide range of applications related to these AM techniques are cited. Furthermore, different feedstock formulations and their corresponding rheological behaviour were explained. Additionally, the most important works about the fabrication of composites using graphene-based ceramic pastes by Direct Ink Writing (DIW) are disclosed in detail and illustrated with representative examples. Various examples of the most relevant approaches for the manufacturing of graphene-based ceramic nanocomposites by DIW are provided.

Keywords: additive manufacturing; graphene oxide; graphene-based paste; direct ink writing; ceramic nanocomposites

1. Introduction

A ceramic is a nonmetallic, inorganic solid [1], which has exceptional and diverse physical and chemical properties that characterize it as a multipurpose material. Typical properties that can be found in ceramics materials are ultra-high-temperature ability, excellent wear resistance, great hardness and mechanical strength, high melting points, good thermal stability, and chemical inertness, low density, and low electrical and thermal conductivity. Thanks to these properties, ceramics are used in multifunctional applications such as biomedical engineering, electronics, aerospace, chemical industry, and machinery [2]. Note that the advantage of ceramics over other materials is the ability to obtain predetermined characteristics by changing the raw materials composition and the production technology [3-8]. Commonly, raw materials are composed by mixtures of ceramic powders with or without binders and additives, and these mixtures are used to form green bodies with desired simple shape by different forming methods as dry pressing, slip casting, injection molding, gel casting, tape casting, extrusion and others [9,10]. After forming, the green parts are very soft; therefore, it is necessary to apply heat upon them to get a dense product by sintering. Sintering can be defined as a thermal process at higher temperatures with or without pressure for compacting and forming a solid structure via mass transport events that often occur on the diffusional processes [10,11]. Although traditional methods of ceramic forming are well studied and widespread, they have several drawbacks such as high cost, long processing times and the impossibility of producing pieces with interconnected holes or with highly complex shapes. In addition, for obtaining a sintered ceramic part with high surface quality and accuracy, mechanical
post-processing work is necessary. This post-process work is expensive and time-consuming due to their natural high hardness and brittleness of ceramics materials [2,12].

Over the past 30 years, a new technology for processing materials called additive manufacturing (AM) has been developed rapidly and it is being introduced more and more every day in a wide range of fields. AM, also known as three-dimensional (3D) printing technologies [13], can be described as a technique of blending materials by either fusion, binding, or solidifying materials such as liquid resin and powders of different materials. It builds a part in a layer-by-layer fashion using 3D computer-aided design (CAD) modeling [14].

AM involves a group of advanced manufacturing technologies that allow the flexible production of highly complex and precise structures that are difficult to realize using traditional fabrication methods like casting and machining [15].

In 2015, the International Organization for Standardization Technical Committee (ISO/TC 261) on AM together with the American Society for Testing Materials (ASTM) Committee F42 released a new International Standard ISO/ASTM 52900:2015 in which the terms used in AM are established and defined [16]. In this standard, the AM technologies have been classified into groups taking into consideration the feedstock type, the deposition technique, and the fusing or solidification way of material. Table 1 categorizes the most popular AM technologies in the industry today into the following groups: vat photopolymerization, material jetting, binder jetting, powder bed fusion, direct energy deposition, sheet lamination, and material extrusion.

<table>
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<th>Category</th>
<th>Additive Manufacturing technology type</th>
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<td>Vat photopolymerization</td>
<td>Stereolithography</td>
<td>SLA</td>
<td>Liquid photopolymers, hybrid polymer-ceramic, hybrid polymer-graphene.</td>
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<td></td>
<td>Digital Light Processing</td>
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<td>Powder bed fusion</td>
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<td></td>
<td>Selective Laser Sintering</td>
<td>SLS</td>
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<td></td>
<td>Selective Laser Melting</td>
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<td>Material jetting</td>
<td>Material Jetting</td>
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<td></td>
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<td></td>
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<td>Material Extrusion</td>
<td>Fused Deposition Modeling</td>
<td>FDM</td>
<td>Thermoplastic polymers, metal-, ceramic-, graphene-reinforced polymers.</td>
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<td>Direct Ink Writing</td>
<td>DIW</td>
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<td>Direct Energy Deposition</td>
<td>Electron Beam Additive Manufacturing</td>
<td>EBAM</td>
<td>Metals and alloys in the form of powder or wire.</td>
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<td></td>
<td>Laser Engineering Net Shape</td>
<td>LENS</td>
<td></td>
</tr>
<tr>
<td>Binder jetting</td>
<td>Binder Jetting</td>
<td>BJ</td>
<td>Ceramic, metal, gypsum, sand.</td>
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<tr>
<td>Sheet Lamination</td>
<td>Laminated Object Manufacturing</td>
<td>LOM</td>
<td>Ceramic, metal-filled tapes, paper, polymer composites.</td>
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The main differences between each of the categories mentioned above can be summarized as follows:

- **Vat photopolymerization** uses a liquid photopolymer resin from which a 3D object is obtained layer by layer thanks to the curing under the influence of an ultraviolet (UV) light. The local interaction of UV light with the photopolymer produces its polymerization, and the UV light path on the resin surface is coordinated thanks to the help of mirrors controlled by motors. When a resin’s layer is cured with the required pattern, its support is immersed in the liquid polymer to form the new layer of the model [17];
• **Material jetting** is a group of technologies that are common compared to the two-dimensional (2D) inkjet printing. Material, which mainly contains a photopolymer, is dropped onto a platform, where it hardens thanks to the expose of a UV light; thereby, a part is assembled layer by layer. Material is dropped from a nozzle which moves on the platform surface [17];

• In **binder jetting** the 3D object is formed layer by layer, when a liquid binder is supplied by drops onto a powder bed. In this way, the binder acts as glue for the powder layers when it is dispersed by a print head that moves on the powder bed surface forming the necessary pattern. When a layer is formed, the powder bed is moving down by an elevator system. After that, a tiny powder layer is spreading over the past layer and the print head dispenses the binder again to form the next layer [17];

• The **powder bed fusion** technologies utilize an energy source that allows the local sintering or melting between the particles of a material powder. The solid part forming is producing thanks to a layer by layer process. In these technologies, the type of use energy sources can be, for example, lasers or electron beams. Its choice depends on the material powder, for metals is necessary the electron beam and vacuum, while polymers require the use of lasers. Despite this, all the powder bed fusion technologies use a spreading system of the powder material over past layers [17];

• **Direct energy deposition** involves technologies that form parts directly by the melting of powder material as it is deposited. Despite that, the main idea of this technology must be applied for a wide kind of materials (polymers, ceramics, and metal framework composites) it is predominantly used with wire or metal powders. This fact explains why this technology is often called metal deposition. This technology uses a nozzle that can move freely in any direction of the x, y and z axis to deposit the raw material onto the predetermined surface and where it is automatically melted and solidified [17];

• In **sheet lamination**, the part is formed from sheets of material that are then bonded. First, a single layer of solid material is put onto the work surface and bonds it to the previous layers. Then a necessary 2D pattern is cutting into the last bonded layer. After that, a new sheet of material is put onto the preceding layer and all the process is repeated;

• **Material extrusion** includes different technologies that extrude material through a nozzle onto a platform. Depending on the used material this technology can use a thermal source for polymers melting to get the optimal rheological properties for extruding. In other cases, a paste with a controlled composition of solid and liquid phases is used. The nozzle moves over the platform drawing the necessary pattern for creating a 3D part layer by layer. In the last past years, this technology became popular in the world for its use in the 3D printers [17].

The introduction of AM into the ceramic forming process proposes a powerful way of producing complex 3D parts. However, despite the wide variety of AM technologies, only a few of them can be implemented for printing ceramic parts [13]. Among such technologies, the so-called Direct Ink Writing (DIW) offers greater versatility and particular suitability for the fabrication of ceramic parts [18]. DIW, also referred to as Robocasting [19], is an extrusion-based technique [20,21] used in 3D printing in which new materials can be implemented most economically and flexibly [22]. The main requirement of this technology is the use of pastes with controlled rheological behaviour [23] that allows them to be able to be extruded into filaments capable of maintaining their shape [23] and not collapsing during the 3D object forming process [24]. The required rheological characteristics can be achieved through the correct selection of the number of components, solid phase parameters and the additives used [24].

In the industrial manufacture of ceramic parts, it is very common the use of a slurry that contains various additives, such as plasticizers, dispersants, surfactants, binders, defoamers, lubricants, etc., which in many occasions produce the formation of defects during sintering [25-27]. These defects can be related to the evaporation of the aforementioned additives that leads to volumetric shrinkage and crack formation, which considerably reduce the mechanical properties of the part [1,28].

Some years ago, the use of chemically modified graphene (in other words, graphene oxide (GO)) has been proposed with aim of prepare an aqueous paste without any additive for the 3D printing of graphene-based heaters [29]. Later, García-Tuñón et al. [30] formulated free additives pastes of
diverse materials, based only on the use of GO as a dispersant, rheological modifier, and binder. It was possible, because GO has a great similarity to clay, including its viscoelastic behaviour. Clay has a unique structure and chemistry that allows the formulation of water-based suspensions with ideal viscoelastic behaviour for shaping in a way that cannot be done with any other natural material [31,32]. The special combination of surface chemistry and the structure of GO sheets in contact with water under special conditions allow the preparation of a very stable GO suspension with viscoelastic behaviour comparable to clay [30,33,34]. In addition, GO as an oxide can be homogeneously dispersed in water, and, consequently, mixtures of graphene oxide with any ceramic oxide can be processed following conventional ceramic processing routes [35-39]. Therefore, the implementation of GO to obtain ceramic pastes without additives for their use in AM opens up new possibilities for obtaining complex parts with the help of robocasting technology.

The aim of the present work is to explain the state of the art of the most common AM technologies used for the manufacturing of complex shape structures of both ceramic and graphene-based parts; and, disclose the most important works about the fabrication of composites using graphene-based ceramic pastes by DIW. Where it was necessary, an explanation of important aspects of AM techniques for ceramic or graphene-based materials will be presented. Moreover, overviews of diverse examples of graphene-based pastes for DIW are given. In where it was possible, historical facts of diverse AM techniques were explained.

Our review article is organized as follows: in Section 2 we present a brief overview of the AM processes for ceramic, which are grouped by the type of feedstock used in each technology; besides, we tried to summarize their principles and applications, and to provide their most important historical facts. Section 3 describes in more detail the AM processes used for 3D printing of graphene-based materials and cites some studies in a wide range of applications related to these AM techniques. Different feedstock formulations and their corresponding rheological behaviour were explained. Section 4 is focused on the more actual developments on direct ink writing by the use of graphene-based ceramic pastes. We provide some examples of the most relevant approaches for the manufacturing of graphene-based ceramic composites by DIW. Finally, in Section 5 a summary of this work is described.

2. Additive Manufacturing processes for ceramic and their principles

The beginning of AM technologies dates back to July 16, 1984, when André J.C., Le Mehauté A. and De Witte O. filed a patent at Cilas Alcatel [40], in which the stereolithography process was proposed. Three weeks later, on August 8, 1984, Charles W. Hull filed his patent at UVP, Inc. [41] and coined the term “stereolithography” (SLA). After that, the development of AM was followed by technologies as powder bed fusion, fused deposition modelling (FDM), inkjet printing and others [42]. However, it was only in the 1990s when the first reports of 3D printing of ceramic materials appeared [43, 44].

Today there is a wide variety of AM technologies used for different types of materials. Table 1 lists the most popular manufacturing additive technologies in the industry, and the possible types of feedstock that can be used in each technology. From this, it is easy to appreciate that not all AM technologies are suitable for the processing of ceramic materials [13].

In 1991, Professor J.P. Kruth first organized the AM processes according to the form of the used material before printing [45], and his classifications were: powder, solid and liquid-based techniques. Using this principle, it is possible to group the AM technologies for ceramic materials into powder-based, bulk solid-based, and slurry-based [13], as shown in Figure 1.

In addition, it should be noted that the traditional ceramic forming technology such as dry and isostatic pressing, sliding and tape casting, etc. have some limitations. They cannot be used for parts with complex shapes (with inner holes, sharp corners, etc.), and which require high precision. Moreover, these forming methods need the manufacture of molds and post-processing, which is time-consuming and costly [46,47]. Meanwhile, AM technologies such as powder-, slurry – and bulk solid-based techniques are promising methods for producing near net complex shape parts and
consequently allows for saving time and reducing production costs of required products in comparison with traditional forming methods.

Figure 1. Classification of AM technologies for ceramics by the type of feedstock used: SLS – Selective Laser Sintering; BJ – Binder Jetting; SLM – Selective Laser Melting; SLA – Stereolithography; DLP – Digital Light Processing; TPP – Two-Photon Polymerization; IJP – Ink Jet printing; LOM – Laminated Object Manufacturing; FDM – Fused Deposition Modeling and DIW – Direct Ink Writing.

2.1. Powder-based technologies

In this group of AM technologies for ceramic materials, powder beds are used. During the additive process, the ceramic powder can be bonded by melting, sintering, or a binder agent, depending on the type of technology used. Among the AM technologies that utilize powder beds, for ceramic materials three of them are the most important in the industry: selective laser sintering (SLS), selective laser melting (SLM) and binder jetting (BJ).

2.1.1. Selective laser sintering (SLS)

This method was first reported by Deckard when he filed a patent in 1986 at the University of Texas [48], and the main goal of this technology was to make wax models for investment casting of metallic prototypes [13]. The SLS process belongs to the category “Powder bed fusion”, and it utilizes a high power laser beam as a thermal source for the local sintering of a thin layer in the powder material surface. When the powder is heated enough by a laser beam a diffusion process takes place between particles in the powder, which leads to the densification of the material. The part forming is a layer by layer process. In this way, when a layer is sintered, the powder bed moves down by an elevator system, a new powder layer is distributed onto the previous surface using a spreading system, and then a new cycle of sintering, descent, and spreading is repeated until the final part is formed. Figure 2a shows a schematic diagram of the SLS process.
Figure 2. Schematic diagrams of powder-based AM technologies main methods: (a) Selective laser sintering (SLS) and Selective laser melting (SLM); (b) Binder jetting (BJ). Adapted with permission from Ref. [301]. Copyright 2018, Wiley-VCH Verlag GmbH & Co. KGaA, Weinheim.

The powder bed can be a single material with a low melting point, or a mixture of a high melting point material together with inorganic [49-54] or organic [55-57] binders which may need debinding by high-temperature heat treatment [58] to get the final part. The SLS process must be carried out in vacuum or inert atmospheres such as argon and nitrogen to avoid the oxidation of the binder during sintering. An advantage of this method is that it does not need the creation of additional supports since the low sintering temperatures do not produce internal stresses that can deform the fabricated part.

Although the laser beam can generate a high local temperature, it is not enough for the sintering of the ceramic materials. Thus, it also requires a long dwell time of the laser beam exposition for ceramics. A solution can be to coat or mix the ceramics with materials of lower melting points that will act as binders [13]. This approach was used by Lakshminarayan et al. in 1990, when they reported the first complex shape 3D part obtained by SLS [49, 59].

Moreover, two major problems related to SLS of ceramics are the high shrinkage and the high porosity remaining in the final parts [60]. On the other hand, the benefit of this method is that no extra support structures have to be intentionally prepared for overhanging regions during an SLS process, as they are surrounded by the loose powder in the bed at all times. Thus, the properties of the parts produced by SLS are affected by several factors associated mainly with the feedstock materials and laser–material interactions should be taken into account during the fabrication process.

2.1.2. Binder jetting (BJ)

Binder jetting is a process invented 1989 by Sachs et al. when they filed a patent for it at Massachusetts Institute of Technology [61], and thanks to its main characteristics, it belongs to the category “Binder jetting”. The principal objective of this technology was to rapidly produce of parts from a larger variety of materials [13] as plastics [62], metals [63] and ceramics [64]. The BJ process utilizes an organic binder solution that is dropped into a powder bed for the gluing of particles in the surface by a printhead in determined paths. The scheme of the BJ process is shown in Figure 2b.

The first report about the application of the BJ process on ceramic materials was made by Sachs et al., in 1992, when they used a matrix of alumina and silicon carbide with a colloidal silica as a binder [64]. Any ceramic powders, which are easier to prepare than wires, sheets, or ceramic slurries, can be used to prepare ceramic preforms, and color printing all of these provide the benefit of BJ with regards to other fabrication methods. However, it must be mentioned that the accuracy and strength of ceramic parts are closely related to powder, binder, printing parameters, equipment, and post-treatment.

In BJ, like SLS, the part forming is a layer by layer process. When a layer is solidified, a new powder layer is distributed onto the previous surface using a spreading system, and then a new cycle
of gluing and spreading is repeated until the final 3D part is formed. After the part was fabricated, the organic binder must be removed by sintering to obtain the desired mechanical properties. The debinding generally produces shrinkage and porous in the part that depends on the binder percentage in it. The mechanical properties are negatively affected by the amount of porosity in the model. Despite this, BJ is a good method used in biomedical fields for the ceramic scaffold production, thanks to porosities that facilitates the cell cultivation purposes.

In the future, if the problem of accuracy and strength can be solved, binder jetting can become a universal method for preparing ceramic parts, producing a preform of any complicated shape that does not shrink after post-treatment.

2.1.3. Selective laser melting (SLM)

The SLM method was first reported in Germany by Wilhelm Meiners et al. when they filed the patent DE 19649865 in 1996 [65]. This process is considered a variant of SLS, but with a thermal source in the form of a laser beam, with much higher energy densities [13] for the local sintering of material. In this way, SLM also belongs to the category “Powder bed fusion”. The presence of a more power thermal source allows the sintering process to be carried out in a single step and without the presence of second phases with low melting temperatures as binders.

The conceptual principle of the SLM is the same as SLS, and it means the part forming is a layer by layer procedure (Figure 2a). The thermal source allows the formation of denser parts since the powder particle is completely melted into the liquid phase ensuring rapid densification without the need for debinding. Initially, SLM was designed as a technology to fabricate 3D objects from metal powders [66] and throughout the time, this technique remains very popular among AM technologies for metals thanks to the ability to manufacture parts quickly and efficiently. But, the inclusion of SLM in the ceramic parts manufacturing involves the reaching of complete melt of the ceramic powder by a laser source without the use of binders or secondary processes [13]. This represents a serious technological problem since the melting points of ceramics are very high and this leads to its limited application in the area of ceramic production [13].

Besides, one of the most significant problems arising from the SLM process is the thermal stress induced by extremely short laser–powder interaction times, namely, the drastic heating and cooling rates upon each laser scan [67]. Cracks and distortions, large open pores and rough surface finishes, low dimensional accuracy as well in the SLM-fabricated parts were reported in previous works [67-70].

The correct control and management of the energy applied to the powder are of great importance since the application of low energy levels leads to the incomplete melting of the material, and on the other hand, under the action of a high energy level, the powder material is spattered around it [71]. Despite this, SLM is the only perspective method that promises to get ceramic parts with full density directly after its use.

Accordingly, just as in the other methods the overall quality of an SLM-produced ceramic part is influenced by many factors, such as feedstock properties, fabrication parameters, fabrication position and orientation, post-processing and the physical and chemical properties of the interaction in the fabrication process, including the interaction of the energy source and the materials.

2.2. Slurry-based technologies

This group of AM technologies for ceramic materials involves the methods that use feedstock, in the form of inks. These inks are liquid systems dispersed with fine ceramic particles. During the additive process, the ceramic parts can be printed by photopolymerization or material jetting, depending on the type of technology used. Among the AM technologies that utilize inks, for ceramic materials four of them are the most important in the industry [13,72]: stereolithography (SLA), digital light processing (DLP), two-photon polymerization (TPP) and inkjet printing (IJP). Note that slurry-based technologies use ceramic/polymer mixtures with low-viscosity inks in th erange of mPa·s and with a low ceramic loading (up to 30 vol%) [13].
2.2.1. Stereolithography (SLA)

Stereolithography imposed the start of the additive manufacturing era in the mid-1980s when a patent about this method was filed [41]. The SLA process utilizes a light source for the curing of a liquid photopolymer tiny layer in a vat containing mainly photopolymerizable monomer along with other additives in very small amounts [73,74]. For this reason, this process is included in the category “Vat photopolymerization”. Commonly, in this method, an ultraviolet (UV) light source is used. This UV light scans the surface of the photopolymer, following a controlled path, thanks to the help of motorized mirrors. A schematic diagram of the SLA is shown in Figure 3a. When a photopolymer interacts with the UV beam, the light activates a series of reactions that are known as polymerization. Polymerization is a process wherein monomers crosslink to form polymers, resulting in a phase change from liquid to solid resin [75]. In SLA the part forming is a layer by layer process. In this way, when a part layer is polymerized its support is lowered a distance equal to the thickness of the new layer by an elevator system. After that, a new cycle of polymerization and lowering is repeated until the final part is formed. The Figure 5 shows a scheme of the SLA process.

The first study of SLA with ceramic particles was reported in 1994 [76]. The authors used slurry with a very high concentration of particles, about 65 vol%. Commonly, the SLA of ceramics uses fine ceramic particles that are dispersed in the liquid photopolymer [76-81]. In this case, the photopolymer is cured by light irradiation creating a solid resin with an uniform distribution of ceramic particles. After the fabrication of a 3D part, this green body must be processed at high temperatures to eliminate the organic compounds and to rich a higher density.

As a slurry-based AM technology, the feedstock must have certain essential requirements to obtain a good result during the polymerization. First of all, there is the need to be a suspension with a high and homogeneous distribution of the ceramic particles. Also, this suspension must have a good rheological behaviour that includes an optimum viscosity in each case of material and good stability of the suspension over time [17].

The advantages of this method are high resolution, accuracy, smooth surface, accommodate large build areas, and the ability to build intricate geometries [82].

However, this technique is still limited to ceramic materials not absorbing in the UV range and presenting a weak variation of refractive index with the photosensitive organic matrix. Indeed, the introduction of small (<1µm) ceramic particles in a curable monomer increases a level of complexity in comparison to the classical fabrication of pure polymeric materials. The main difficulty is due to the scattering phenomena, which first reduce the cure depth and then increase the processing time and secondly decrease the dimensional resolution.
2.2.2. Digital light processing (DLP)

The DLP process is an improved version of SLA, in which a UV light source is not used for the solidification of the photopolymer. In this process, a white light source is used to project the cross-sections of the 3D part, one projection at a time, with the help of a digital mask [74]. The idea of this process was invented by Nakamoto and Yamaguchi in 1996 [83] when they used a physical mask instead of a digital projector. This process, as well as the SLA, also belongs to the category “Vat photopolymerization”.

During the DLP process, the liquid photopolymer is exposed to the direct projection of the sectioned figure of the model for its polymerization with the help of the digital mask [84, 85]. Then, the solid surface changes its vertical position, thanks to the help of an elevation system, changing the planar focus for the projection and formation of the new layers with the required sectioned shape of the 3D model. This process is repeated until the part is completely fabricated. Figure 3b shows a scheme of the DLP process.

DLP compared to SLA is a much faster and cheaper process that has a very high resolution [86] thanks to the easy choice of the optimal size of the projected pixel [74]. These advantages make it a very attractive process for the ceramic industry [87, 88]. The use of this method in the production of ceramic pieces has acquired a great impact, and to this day it is one of the most used techniques thanks to the possibility of obtaining pieces with high densities and hardnesses [89, 90] including a high quality of the surface. The DLP technology used exclusively for ceramic materials is generally marketed under the name of lithography-based ceramic manufacturing (LCM) [91]. Generally, this method is used to fabricate heat exchangers [92], metamaterial structures [93] and cellular ceramic structures with very small feature sizes [94].

At the same time, the main disadvantages of this technology compared to SLA are: parts cannot be left out in the sun or they will degrade; parts overall have worse mechanical properties — they break or crack more easily and are at risk of deteriorating over time; resins are expensive, and the regular replacements of resin tanks and occasionally print platforms also adds up.

2.2.3. Two-photon polymerization (TPP)

Two-photon polymerization (TPP) is an AM technology related to the “Vat photopolymerization” group in which a multiphoton polymerization-based process is used [74]. The principal purpose of this method is to utilize the nanoscale fabrication of parts for their application in different areas such as nanoelectronics, nanomechanics, and nanobiomedicine [13]. The first work-related with the TPP field was carried out by Wu et al. in 1992 to get high-aspect-ratio trenches of simple shapes [95]. Later, this process was improved and applied to fabricate complex forms, as was shown in the work of Maruo et al. in 1997 [96].
The polymerization process in TPP is based on the interaction of two or more photons from a laser with a specific wavelength [13] when it focuses on a specific point within a liquid photopolymer [96-97]. A schematic diagram of the TPP is shown in Figure 3c. After polymerization of a certain volume of material, the focus point of the laser is moved for the formation of the following layers. The final resolution and the quality of the surface obtained depend directly on the precise positioning and control of the size of the focal point [74].

The advantages of TPP are mainly related to the possibility of polymerizing tiny volumes at high speed within the photopolymer [98] which gives the possibility of manufacturing microstructures with lateral feature sizes in the order of nanometers [99-100]. The use of a technology with this type of characteristics for the ceramic part production with complex shapes opens up new and interesting possibilities for this industry.

The first work on TPP for the obtaining of ceramic parts was published by Pham et al. [101]. In this work, a SiCN woodpile nano- and microceramic microstructures of submicron resolution [13] was created.

This technology has a series of restrictions that limit its use and among these, we can define: very expensive, time-consuming, and challenging for complex structures. [74]. Furthermore, the working principle of TPP allows only the use of transparent polymers; this means that the opaque polymers that were usually used for SLA and DLP processes are not applicable for TPP. It should be noted that this process can produce only very small parts on the order of a few microns and due to the high precision of the process; it also takes a longer amount of time to completely manufacture a part.

2.2.4. Inkjet printing (IJP)

Inkjet printing, sometimes known as material jetting, is a non-contact method of AM mainly created to obtain two-dimensional patterns inspired by a technology developed in the 1950s [102]. The IJP process is based on the controllable dispensing of liquid-phase materials by the use of micrometer-sized printhead nozzles [103] that is the reason why this technology is related to the Material jetting category. The liquid-phase material, also known as Ink, is dispensed onto a surface by droplets in a specified pattern in which the ink drying occurs forming a thin layer of the ink residue. After that, new layers can be placed on top of each other to form a multilayer 3D object. The IJP processes can use one of the main two methods of ink dispensing: continuous inkjet (CIJ), or drop-on-demand (DOD) printing [104]. Figure 4 shows the printing methods used in IJP.

![Figure 4. Schematic diagrams of printing methods used in Inkjet printing: (a) continuous inkjet (CIJ); (b) drop-on-demand (DOD).](image-url)

The CIJ method involves the production of a stream of drops jetting out through a controllable micronozzle [74]. Then, the formed droplets pass through an electrostatic field that influences them and deflects their trajectories to print on a substrate or allows them to follow their movement towards a collector for reuse. In this way, only small quantities of droplets are used for printing, and the largest number of drops is recycled, i.e. CIJ is a non-economical material process. The DOD method
produces ink droplets when and where it is required, thus this method is more economical than CIJ. Moreover, the small size of droplets and the high positioning accuracy make it more ideal for 3D printing [13]. In DOD the droplets can be formed by piezoelectric effect or thermal excitation in the printing nozzle head [105]. Piezoelectric DOD utilizes a piezoelectric element located in the fluid chamber near the nozzle head for the droplet formation [106]. In this case, the droplet is created and ejected by a generating pressure pulse that forces the ink to leave the nozzle head [105]. The pressure pulse is formed thanks to the piezoelectric element deformation under the application of a voltage. When a droplet is ejected, it falls by the gravity then it impregnated in the subtracted thanks to the momentum obtained during its movement [74]. After that, occurs the solvent evaporation from the impregnated droplet creating a small layer made up of the ink residue. In thermal DOD process, sometimes named as bubble jet printing [74], a thermal excitation for the formation of the droplets and ejecting is used. The thermal excitation is generated when a pulse current crosses through a heating element that is located in the fluid chamber near the nozzle head and direct contact with the ink. When the temperature of the heater element reaches the ink’s boiling point rapid ink vaporization is occurred creating a bubble. This bubble formation is followed by a very fast collapse when the pulse current source is “switched off”.

Different types of materials as polymers or metals for electronic patterning [107], solder paste for microelectronics soldering [108] and cells for restoration in tissue engineering [109] were used in IJP. However, the IJP method is limited only to the production of miniaturized parts due to the low ink volume used in each droplet [13]. The obtaining of a solid ceramic part after an IJP process involves the drying and sintering post-processing of the printed part.

Thanks to the development of computational technologies, the increase in positioning precision and advances in the 3D printing field, the use of the IJP method has been achieved for ceramic materials dispersed in liquid solvents [13]. The first report of IJP with ceramic materials dates back to 1995 [110] when Blazdell et al. used ceramic inks (ZrO$_2$ and TiO$_2$) with a volumetric fraction of 5%. After that, different researches groups improved the IJP and the feedstock preparation for obtaining materials with ceramic loading until 40% [111-112].

2.3. Bulk solid-based

This group of AM technologies for ceramic materials involves the methods that use material sheets, semi-molten [74] or semi-liquid systems [13] in which fine ceramic particles are well dispersed as feedstock. Note that semi-molten and semi-liquid systems, commonly of ceramic/polymer mixtures, have a high-viscosity in the range of some Pa-s like pastes with a greater ceramic loading (up to 60 vol%) [13]. In this group, some AM technologies that belong to different categories such as Sheet lamination or Material Extrusion will be considered. Among the AM technologies that utilize solid feedstock for ceramic materials are laminated object manufacturing (LOM), Fused Deposition Modeling (FDM), and direct ink writing (DIW) that are the most important in the industry [13,72].

2.3.1. Laminated object manufacturing (LOM)

Laminated object manufacturing is a process related to the Sheet lamination group and it was mainly developed for the fabrication of metal, paper or plastic parts. The first report of this method was in 1984 when Kunieda published his work “Manufacturing of High Cycle and High Precision Injection Molds by Diffusion Bonding of Laminated Thin Metal Sheets” in which molds for injection molding of plastics were obtained by laminating metal sheets cut by laser [113]. As said before, the concept of this method is to utilize, generally obtained by laser cutting, tiny pre-patterned material sheets that are stacked on top of each other and bonded by either using a heat [114,115] source or adhesives [13,74] to form 3D parts. The type of the used joining process is depending on the raw material. For instance, sheets of metal materials are bonding by the use of ultrasonic processes that produce local heating of the sheets creating a very strong bond [116]. For paper sheets, an adhesive material, as glue, is used. In the case of polymer materials, the use of heat and pressure is necessary [117,118]. Generally, this method needs a machining post-process to reach the final shape, surface quality and accuracy of the part. Figure 5a depicts the process scheme for LOM.
Laminated object manufacturing exhibit several advantages such as low process and machine cost, high volumetric build rate, low material requirement, high surface finish and the ability to obtaining parts of combination material and composites [119,74]. However, this technology has some disadvantages such as the necessary use of tiny sheets of material, different bonding processes for different types of materials and a non-high resolution of complex parts.

Only after 10 years that Kunieda published his work, the first report about LOM with ceramic materials appeared [120,121]. The authors of this work, Griffin et al., used sheets of alumina and zirconia for the manufacturing of solid parts with a high density after removing the binder and sintering at high temperatures.

After Griffin’s investigation, a large number of materials such as Al₂O₃ and SiC [122-125], binary composites like ZrO₂/Al₂O₃, Si/SiC, TiC/Ni [126-128], or more complex systems, for example, LiO₂–ZrO₂–SiO₂–Al₂O₃ (LZSA) glass-ceramic composite [129] have been investigated for they use in LOM.

Despite the great effort made in the study of ceramics for LOM, in recent years no progress has been observed in this field. Thus, the application of this technique is restricted only for the manufacture of ceramic parts with simple geometry, and large sizes, which create a problem for its application in the production of advanced ceramic components that, are generally characterized by their complex geometry and much times for its miniature sizes.

![Schematic diagrams of bulk solid-based AM technologies main methods](image-url)

**Figure 5.** Schematic diagrams of bulk solid-based AM technologies main methods: (a) Laminated object manufacturing (LOM); (b) Fused Deposition Modeling (FDM); (c) Direct ink writing (DIW). Figures 5 (a and b) adapted with permission from Ref. [301]. Copyright 2018, Wiley-VCH Verlag GmbH & Co. KGaA, Weinheim.
2.3.2. Fused Deposition Modeling (FDM)

FDM, also named fused deposition of ceramics (FDC), was first reported by Crump when he filed his own patent US 5121329 “Apparatus and method for creating three-dimensional objects” in 1989 [130]. Nowadays, this process is considered as the most usual AM technology in the world thanks to its accessibility, easy in use and low cost [131,132]. Different types of materials can be utilized in FDM process, such as polymers, metals, and ceramic-or metal-filled polymers [29]. The main concept of the FDM process is to create a part layer by layer [133] by supplying a filament of semi-molten materials. The feedstock is a thermoplastic polymer filament such as acrylonitrile butadiene styrene copolymers (ABS), polycarbonate (PC), Polyamide (PA) and polyactic acid (PLA) [134] that is permanently providing to a nozzle which is heated at a temperature just above the filament melting point [13]. The semi-molten material is extruded through the moving controlled nozzle to form the desired pattern [72]. After the extrusion, the filament adheres to previously deposited layers and immediately cools allowing its solidification. When a layer is solidified with the desired pattern the part support is lowered a distance equal to the thickness of the new layer by an elevator system and a new cycle of extrusion and lowering is repeated until the final part is formed [17]. The schematic diagram of the FDM process is shown in Figure 5b. Generally, FDM technology is widely used to manufacture parts with poor surface finish, low resolution, and mechanical properties. These low characteristics are commonly related to the influence of many factors such as material properties, air gap, printing orientation, raster angle, layer thickness, and raster width [74,135]. For this reason, the polymer parts obtained by FDM are often used as conceptual prototypes [135].

For the application of FDM in ceramic production, it is necessary to prepare filaments composed of binder thermoplastic polymers and tiny ceramic particles with a loading of about 60 vol%. The ceramic particles should be well dispersed in the filaments so that a constant and stable flow can be attained [17], moreover the viscosities of the fused filaments should generally range from 10 to 100 Pa-s [13]. Once the green body is obtained by FDM, the elimination of the binder polymer and the sintering are necessary to get the ceramic part. As Danforth reported in the first work about ceramic part fabrication by FDM in 1995 [136], the debinding step leads to the formation of pores that directly influence on the formation of defects and obtaining low densities. Despite this, thanks to the successful development of this technology and material science, the mechanical properties of parts obtained by FDM are now comparable with other processing routes [137]. This is why the application of FDM for ceramic production is successfully expanding into various fields as electronic components [138], biological parts [139], sensors [140], bioceramic scaffolds [141-145], and others [146,147].

2.3.3. Direct ink writing (DIW)

Direct ink writing is a process related to the material extrusion group and it is also known as Robocasting [148], Direct Write Fabrication [149] or Robot-Assisted Shape Deposition [150]. DIW was first reported by Cesarano and Calvert when they filed a patent at Sandia National Laboratories on October 28, 1997 [151,152]. DIW is a simple, flexible, and inexpensive approach, suitable for many kinds of materials, such as ceramics, metal alloys, polymers, and even edible materials [153], this is the most versatile method to fabricate 3D prototypes [154], which its main goal is to make parts by extrusion of concentrated suspensions formulated of main material together with additives to get appropriate viscoelastic behaviour [13,72]. The concept of this technique is very close to de FDM with the difference that the DIW process depends on the feedstock rheology behaviour to maintain the shape of the printed part in the time [148]. The high viscosity (103–106 mPa s) and shear thinning behaviour (a decrease of viscosity with an increase of shear forces inside the nozzle) of the feedstock are indispensable for this technique [20,154,155]. In this way, the pseudo-plastic feedstock is extruded by compressed air through a moving controlled nozzle to form a desired two-dimensional pattern [72]. In DIW the possibility of nozzle clogging is much lower than IJP [156]. When a layer was printed the part support is lowered a distance equal to the thickness of the new layer. After that, a new layer is deposited on top of previously deposited forming a part thanks to a layer by layer procedure. As other technologies of ceramic production debinding and sintering post-processes are necessary to
obtain a ceramic part without organics. Figure 5c demonstrates a schematic diagram of the DIW process.

This technology for ceramic materials, compared to SLA, is much faster and cheaper. The exclusive use of ceramic pastes with required viscoelastic behaviour allows printing figures that can maintain their original form regardless of the loads generated by the newly deposited layers on them. Generally, the used pastes have a high loading of ceramic particles and optimal content of additives. Thanks to this, it is possible to build parts with different configurations from complex porous scaffolds [21], to composite materials [157] and solid monolithic parts [158]. Moreover, some researchers could prepare and use for printing filaments with different cross-sectional forms [159, 160].

Thanks to the flexibility and simplicity of DIW, other scientists have been able to implement this technology for the fabrication of parts with periodic structures [26,161], for electrodes for lithium-ion (Li-ion) batteries [162, 163] and, in recent years, the manufacture of bioceramic implants [19,164,165]. The last is the prominent application thanks to/as a result of the porosities that appear in the part after sintering. These porous structures are preferred in the manufacture of ceramic implants because they promote the growth of human body tissue in them [167-169]. Thus, DIW is well suited to the fabrication of tailored porous ceramic structures possessing periodic features, with little or no surface resolution needed [13].

The aforementioned results show that DIW is a prominent technique for obtaining ceramic pieces with complex geometry, but with the great disadvantage that it is not possible to obtain highly dense pieces, which limits their application in the industry.

3. Additive Manufacturing for graphene-based materials

As previously stated, in the last few years AM technologies have become so popular throughout the world that they have come to be applied in different fields of science and industry using different types of materials such as polymers, metals, ceramics, and composites. At the same time, in the last 20 years the development of materials science, specifically in the area of nanotechnology, has allowed the appearance, study, and development of interesting and perspective new materials, which are known as nanomaterials, for their application in the industry [36,170]. Micro- and nanomaterials of the same compound differ in that the latter can have exceptional and never-before-seen optical, electronic, and mechanical properties in comparison with the first. The great interest in nanomaterials is also because the properties of macro materials drastically change when nanomaterials are added to their structure [171,172]. Thanks to this, many ceramic-based composites that have a certain percentage of nanomaterials are converted into materials with improved mechanical properties. One of these promising nanomaterials is graphene [173,174]. Graphene is a revolutionary material that opens wide perspectives with its use, as an example, for increasing the flexural strength and fracture toughness of ceramic materials [175, 176]. In the following sections, the characteristics and possible applications of graphene-based material, as well as the most popular additive technologies for them, will be explained in more detail.

3.1. Graphene and its derivatives materials

Graphene is a two-dimensional carbon allotropic form consisting of a single layer of sp2 hybridized atoms that are organized in a honeycomb lattice structure [177]. Graphene was discovered in 2004 by Andre Geim and Konstantin Novoselov, who worked at the University of Manchester. This material demonstrates unique properties such as very high thermal conductivity (above 5000 W mK⁻¹) [178,179], high modulus of elasticity (1 TPa) [180], large surface area (2630 m²/g) [181], high electron mobility in room temperature (250.000 cm²/V s) [182] and high tensile strength of 130 GPa [180]. Moreover, graphene shows high light transmittance [183], very high electrical conductivity [184], and complete impermeability to any gases [185] that make it a very promising material for a large number of multifunctional applications such as medicine [186], composite materials [187,188], electronics [189], light processing [190], supercapacitors [191], energy [192], strain sensors [13] and others [193,194].
Different methods of obtaining graphene have been investigated, but the most used are chemical vapor deposition [195], epitaxial growth [196], the mechanical, oxidation-reduction method [197], and liquid phase and electrochemical exfoliation [198]. It should be noted that the widespread use of pristine graphene is limited mainly because it is hydrophobic [199]. The solution to this problem is the surface functionalization of graphene that is carried out by chemical modification [200,201]. Generally, chemical modification of graphene can be done in two ways: covalent [202], or non-covalent functionalization [203]. Functionalization via non-covalent interactions creates a weak interaction of a π-π, van der Waals or electrostatic type between graphene and the target matter [201], while the covalent modification use the covalent bonding of oxygen-containing functional groups on the surface of graphene, forming carboxylic acid groups at the edges and epoxy and hydroxyl groups at the basal plane [200]. Usually, researchers around the world use processes based on the Hummers method, which are known as the modified Hummers method [204], for the covalent modification. The main idea of the Hummers method is the use of very strong oxidizing agents, such as concentrated sulfuric acid, nitric acid, and potassium permanganate, for the formation of oxygenated functional groups on the graphite [205], which is then mechanically exfoliated to obtain fine sheets of graphene with also functional groups on its surface [206]. This material is called Graphene Oxide (GO) and it is hydrophilic that disperses easily in water [206].

The oxidation of graphene creates a large number of defects in its lattice structure that degrade the material properties, moreover, the functional groups in the GO surface make it electrically insulating [197,206]. Fortunately, a partial restore of graphene properties is possible thanks to a reduction process of GO that can be carried out mainly by chemical or thermal ways, although other less popular routes have also been used [197,206,207]. The idea of the reduction process is to remove the functional groups from the GO surface to obtain reduced graphene oxide (rGO) by the application of reducing agents [208] in the chemical reduction, or by a heat treatment in the thermal [153, 29].

Graphene and rGO differ from each other primarily by the presence of defects and some functional groups that remained in their structure after the reduction process. This fact turns rGO into a material with properties close to graphene and, at the same time, soluble in different media that allows it to be used in industry [209]. For instance, a large number of graphene-based composites have been created to improve the mechanical [210], thermal [211] and electrical [212] properties of polymer matrices used with applications in aerospace, electronics, and energy storage [206,213,214]. Furthermore, graphene-based composites with inorganic matrices, such as metals, ceramics, and composites have been developed [206,215-218].

3.2. Additive technologies for graphene-based materials

Like ceramic materials, graphene and its derivatives materials are also being studied to define their role and use in AM [219]. Since graphene oxide is hydrophilic, it is the most suitable material to be used as a precursor of graphene in additive technologies since this material can be easily dispersed in different solvents, and especially in water. Thus, the appropriate AM techniques to be used with graphene-based materials should belong to the categories vat photopolymerization, material jetting and material extrusion. In this review, only the AM techniques that are more typical for the production of graphene-based composites, in particular SLA, IJP, FDM, and DIW, will be analyzed. Some of these methods are based on the use of polymers; and the introduction of graphene-based material into them allows the obtaining of polymer nanocomposites with improved properties, for example, barrier properties [185,220,221], optical properties [222,223], thermal properties [224-226], electrical properties [227-229] and mechanical properties [224,230-232].

The final properties of polymer nanocomposites crucially depend on the effectiveness of the nanoparticle dispersion process [233]. Thus, a good nanofillers dispersion in the polymer will produce a maximum increase in the properties of the composite [234-237]. In many studies, the process of preparing composites has been taken into account to obtain a high homogeneity and dispersion of graphene-based materials within a polymer matrix [238]. The tactics implemented in different works can be summarized in three strategies [233]: 1- In situ intercalative polymerization. In this method, graphene or GO is first swollen in the liquid monomer, then a suitable initiator is
diffused and polymerization reaction proceeds by heat or radiation; 2 - Solution intercalation. Three steps are involved in this method: dispersion of graphene or GO in a suitable solvent, the addition of polymer and removal of the solvent. Graphene or GO can be dispersed in various solvents by sonication. Then, the graphene-based-solution is mixed with the polymer matrix, which is adsorbed onto the carbon sheets. Next, the carbon sheets sandwich the polymer to form a nanocomposite by removing the solvent, which is crucial for the properties of nanocomposites. The main advantage of this method is introducing low or even no polarity during the synthesis process; 3 - Melt intercalation. Graphene or GO is mechanically mixed with thermoplastic polymer at elevated temperatures by extrusion or injection molding. This method is solvent-free.

Of these three strategies the last two are the most widely used, while, as far as is known, the literature on preparation of graphene-based polymer composites by in situ polymerization before being extruded into filaments for FDM printing is still limited [29].

3.2.1. Stereolithography (SLA)

In section 2.2.1, the history facts, basic principles, advantages and disadvantages of this technique were considered. In summary, SLA uses a liquid photopolymer that polymerizes under the action of a UV light source to fabricate a part with a high resolution [239]. It is necessary to consider two essential issues for SLA-based composites: (1) Rapid solidification of by light initiated polymerization, which requests a fast light-responsive composite resin system; (2) Sufficient low viscosity to allow for the dipping of the resin layer, which determines a low graphene content and homogeneous filler distribution [240].

Over time, the SLA evolved and improved versions of this technique such as DLP, continuous liquid interface production (CLIP), projection microstereolithography (PµSL) and TPP [82,241-243] appeared. These modifications allow manufacturing parts with a higher resolution, shorter manufacturing time and low post-process requirements [244].

In 2015, Lin et al. [233] reported the first manufacturing of GO reinforced complex architectures by mask projection-based Stereolithography (MPSL), also called digital light processing (DLP), with a good combination of strength and ductility. First of all, the expected weight amount of GO nanosheets was sonicated in acetone and then they were dispersed in the polymer resin. This research demonstrated that tensile strength and elongation of printed composite parts with only 0.2 wt% GO increased by 62.2% and 12.8%, respectively. Moreover, this research group noticed a novel fracture phenomenon of 3D printed truss architecture under the compression test. Later, in 2017 an experiment was carried out by Manapat et al. [245] on the manufacture of high-strength nanocomposites by a typical SLA process. In this work, the authors used the GO metastable structure to improve the thermo-mechanical properties of a printed part that was then annealed at low temperature. For this, composites with different GO contents (between 0 and 1 wt%) were prepared by dispersing the GO in acetone and then mixing the as prepared dispersion with a resin. The viscosities of the prepared GO resin varied between 0.6 and 1.6 Pa.s depending on the concentration of GO. Before, the as-obtained GO resins were used to manufacture the 3D parts with an axial resolution of 50 microns, which were then annealed at low temperatures (50 °C and 100 °C for 12 hours). The best results were obtained after annealing at 100°C for the 1 wt% GO nanocomposite that showed a very high increase of 673.6% on tensile strength compared with the casted material (Figure 6) [245].
Figure 6. a) Tensile strength comparison of casted and 3D-printed parts; SLA-printed complex-shaped GO nanocomposites: (b) nested dodecahedron and (c) diagrid ring. Reprinted with permission from [245]. Copyright (2017) American Chemical Society.

The previous work result shows that SLA is a good candidate to be used in the rapid manufacturing of parts based on graphene reinforced composites that can be used in different applications, such as in the biomedicine field. For example, in the work [246] published in 2018, a graphene-reinforced composite for bone structure scaffolds was reported. Here, Feng et al. invented a biodegradable UV-cured resin by SLA to create the personalized complex structure for bone tissue scaffolds, which have been reinforced by the filling of graphene layers. The formulation consists of a commercial polyurethane resin as an oligomer, trimethylolpropane trimethacrylate (TEGDMA) as a reactive diluent and phenylbis (2, 4, 6-trimethylbenzoyl)-phosphine oxide (Irgacure 819) as a photoinitiator. The obtained resin had suitable viscosities for SLA in the order of 847 Pa.s (at 25 °C) and 500 Pa.s (at 30 °C). Thanks to the inclusion and the good dispersion of graphene fillers, the manufactured parts by SLA had improved their mechanical properties when they are compared with the conventional direct casting method. Thus, the tensile strength of the printed part rose to 68MPa from 42MPa that is the value for the same material but produced by direct casting. Other improvements are also been registered in the flexural strength (115 MPa) and flexural modulus (5.8 GPa). Consequently, these results show that this graphene-reinforced resin has a great ability for the production of biological tissue engineering compared to the traditional mold-based multistep methods that have a considerably low cost. Figure 7 [246] shows the images of jawbones, and gyroid scaffolds of pure UV-cured resin and graphene-reinforced nanocomposite manufactured in this work.
A short time ago, Hensleigh et al. [247] investigated the manufacturing of complex micro-architected graphene aerogels by using an “XGO” resin. In this study was demonstrated that graphene containing resin could be precisely patterned by light into any desirable shape with 3D spatial features sizes of $\sim 10$ microns (Figure 8 g, [247]), that is a much higher resolution compared with other works where the obtained feature sizes were on the order of 100 $\mu$m.
Figure 8. (a) Four “Green” MAG parts of differing unit-cell structures before pyrolysis from left to right octet-truss, gyroid, cubo-octahedron, and Kelvin foam; (b) optical image of pyrolyzed gyroid; (c) SEM image of pyrolyzed gyroid with intricate overhang structures (d) zoomed image of pyrolyzed gyroid in “c”; (e) optical image of pyrolyzed MAG octet-truss, of a different design than shown in “a” supported by a single strawberry blossom filament; (f) SEM image of pyrolyzed octet-truss MAG in “e”; (g) zoomed image of octet-truss in “e” showing the very high 10 micron resolution achievable in our process. Reproduced from Ref. [247] with permission from the Royal Society of Chemistry.

In the current state of the art, other graphene-based 3D parts obtained by SLA improved versions as DLP [248,249], TPP [250] and others [244] can be found.

3.2.2. Inkjet printing (IJP)

This technology was widely considered in point 2.2.4 of this paper. It is necessary to remember that in this technique the feedstock should be a low viscosity homogeneous or colloid ink to be able to form spherical droplets for accurate fabrication [154]. Note that nozzle diameter $a$ ($\mu$m) and density $\rho$ (g/cm$^3$), surface tension $\gamma$ (mN/m), viscosity $\eta$ (mPa s) of the ink directly influence on the drop formation [29]; and these ink characteristics must be taken into account during the preparation of the graphene-based feedstock [251-256]. One of the methods for ink preparation is the liquid phase exfoliation [257], in which graphite is first dispersed in a solvent and then exfoliated by sonication. Unfortunately, solvents that could give a better exfoliation result, such as N-methyl pyrrolidone (NMP) and dimethylformamide (DMF), are extremely toxic. For this reason, studies are constantly carried out to find a replacement for these toxic materials [257-259]. Despite the efforts that were made to obtain such materials, the dispersity of graphene suspensions remained poor. A very
practical way to stabilize the inks is to use GO or rGO together with surfactants that improve the dispersity of sheets [257,260,261,262], thereby it reduces the probability of agglomerate formation in graphene-based inks [257].

Different studies on IJP with graphene-based inks have been carried out, mainly for applications in electronic, bioelectronic, and energy storage [263-268]. For example, in 2017 Li et al. [258] reported a simple full-inkjet-printing technique for the scalable fabrication of graphene-based microsupercapacitors (MSCs) on various substrates. The authors prepared an ink based on high-performance graphene with dimethylformamide (DMF) that had a concentration of 2.3 mg/mL of graphene sheets and a stable period of more than half a year. This suspension was used for the fabrication of tiny films (with thickness up to ∼0.7 µm) that served as both the electrodes and current collectors. The fully printed graphene-based MSCs demonstrated an extremely high capacitance of about 0.7 mF/cm², which considerably exceeded the maximum value reached (∼0.1 mF/cm²) in printed graphene-based MSCs [269,270] before this study. Moreover, the authors demonstrated that this approach enabled the scalable fabrication of MSCs and effective connection in parallel and/or in series at different scales [29], for instance, more than 100 devices have been connected to form large-scale MSC arrays as power banks on both silicon wafers and Kapton. Without any extra protection or encapsulation, the MSC arrays can be reliably charged up to 12 V and retain the performance even 8 months after fabrication.

Karim et al. [271] first reported an organic nanoparticle-based inkjet printable textile surface pretreatment which enables all inkjet-printed graphene-based wearable e-textiles. In this study, a way to print a continuous conductive path on a rough and porous textile surface, which is the main problem related to inkjet printing of conductive inks on textiles, was found. Figure 9 displays a schematic diagram of the inkjet-printed graphene e-textile manufacturing process. The textile surfaces were pre-treated with hydroxyl functionalized cross-linked styrene/divinylbenzene nanoparticles (NP1); on the other hand, the rGO water-based ink was prepared using a green non-toxic reducing agent, L-ascorbic acid in the presence of polyvinyl alcohol (PVA). Later, a continuous conductive electrical path of water-based rGO inks onto the pre-treated coating was printed by inkjet printing. The results of this study show that this approach reduces the sheet resistance of graphene-based printed e-textiles by three orders of magnitude from 1.09 x 10⁶ Ω/sq to 2.14 x 10³ Ω/sq compared with untreated textiles. Here, the pre-treatment acts as a receptor layer for water-based rGO inks, which can subsequently be dried at low temperature (100 °C); thus reducing the chance of damaging heat-sensitive fabrics. In this way, inkjet printing of water-based and bio-compatible graphene inks could potentially open up opportunities to manufacture environmentally-friendly next-generation e-textiles for sports, healthcare and military applications. In figure 10 are shown the different conductive patterns that were inkjet-printed onto the NP1 printed area and the untreated area of the fabric.
Figure 9. Schematic diagram of the inkjet-printed graphene e-textile manufacturing process. Reproduced from Ref. [271] with permission from the Royal Society of Chemistry.

Figure 10. (a) SEM images of the inkjet printed silver ink (6 layers) onto untreated cotton (×2000); (b): (1) NP1 (12 layers) printed area; (2) inkjet-printed conductive pattern onto NP1 printed area with silver ink (6 layers) and (3) inkjet-printed silver ink onto untreated area (6 layers); (c) SEM images of the inkjet printed silver ink (6 layers) onto NP1 (12 layers) printed cotton fabrics (×1000); (d) SEM images of the inkjet printed rGO ink (6 layers) onto untreated cotton (×1000); (e) inkjet-printed conductive pattern with rGO onto NP1 printed and untreated area of cotton; (f) SEM images of the inkjet printed rGO ink (6 layers) onto NP1 (12 layers) printed cotton fabrics (×500). Reproduced from Ref. [271] with permission from the Royal Society of Chemistry.

Recently, Asli et al. [265] proposed a method for high-yield production of aqueous graphene for electrohydrodynamic drop-on-demand printing of biocompatible conductive patterns. Here, a facile, scalable and aqueous phase exfoliation of graphite to high yield and quality of few-layer graphene (FLG) using Bovine Serum Albomine (BSA) and wet ball milling was suggested for the first time. The principle of this method is based on the combination of BSA as an exfoliating/stabling agent, with the sheer force of continuous low-speed wet ball milling, for achieving the exfoliation of graphite particles to 2–3 layers graphene sheets on average. The as-obtained graphene suspensions possessed a concentration of 5.1 mg/mL and it remained stable for weeks. This stable graphene dispersion is advantageous during the printing process, as it dramatically lessens the likelihood of clogging issues. Then, the prepared ink was printed on a flexible substrate (Polyimide) with the controlled resolution by the use of an electrostatic field in the drop-on-demand printer. After printing, thermal annealing is essential for the improvement of the conductivity of the printed FLG. On one hand, it leads to the release of possible oxide compounds; and on the other hand, results in the BSA burn-off, which is essential for maintaining the stability of the patterns when in touch with water; moreover, thermal annealing reduces flake-to-flake and flake-to-substrate defects while improving the order of the surface morphology. Thus, the post-processing was carried out in different durations (from 10 to 120 min), and temperatures (from 50 °C to 280 °C). The results demonstrated that no-annealed layer had a sheet resistance of 133 Ω/sq, while annealed samples reduced the sheet resistance to 36.75 Ω/sq in an in a standard oven at 280 °C with a duration of 30 min. After annealing, the conductive layers lines did not lose their adhesion to PI when in touch with water, which is desirable as cell media are typically water-based. This approach has big potential for applications in biosensors, as well as other...
applications in flexible and printable electronics. Figure 11 displays SEM and optical analysis of printed patterns.

**Figure 11.** (a) Drop-on-demand printer setup for the inkjet printing of graphene; (b) SEM for cross-sectional view of printed patterns with magnifications which show a normal height of ≈4 µm; (c) height contour of full printed graphene and sample line through which an average height is reported. (d) The 20x magnified section of the sample print. (e) In distance 0 and 1200 on the sample line (c), the height is measured over the substrate. The maximum measured height is the peak of the printed material. The difference between these two indicates the height of the print (≈4 µm) at maximum which is compatible with SEM imaging. (f) SEM for THE top view of printed graphene after annealing at 280°C for 30 min; scale bar: 20 µm. Reproduced with permission from Ref. [265].

### 3.2.3. Fused Deposition Modeling (FDM)

As we said in part 2.3.2, FDM is a very frequent AM technology that melts and extrudes thermoplastic filaments to form the final 3D part [272]. Thanks to the facility to add different phases in the thermoplastic matrix, this technology can be used for the production of parts with a wide type of composite materials [273]. As an example, the inclusion of electrically conductive carbon allotrope forms like graphene, graphite, carbon nanotubes, and carbon black into the filament of the printed parts can demonstrate an improvement in electrical properties and, as in the case of graphene and CNT, in mechanical properties [219, 274-276].

The first study about the possibility of using graphene-based compounds in FDM to manufacture parts was reported by Wei et al. [277]. In this work, the solution intercalation strategy was used. The authors utilized N-Methylpyrolidone (NMP) as a solvent, to get good dispersion of ABS and GO. After the GO was reduced some quantities of rGO/ABS powder formed and precipitated from solution. Next, this powder was used for the preparation by extrusion of a filament that would later be used for the manufacture of parts by FDM. The maximum content of graphene in the manufactured filaments was 7.4 wt%.

In recent years, different studies have been carried out on the application of graphene-based composites in FDM to be applied in different areas, as well as biomaterial scaffolds [278], electrochemical energy storage architectures [279, 280], and flexible circuits [281].

For example, in 2017 Chen et al. [278] fabricated scaffolds for tissue engineering by application of thermoplastic polyurethane (TPU)/PLA/GO nanocomposites and explored their biocompatibility. These nanocomposites were obtained by a solution intercalation strategy and then the as obtained mixtures were precipitated in alcohol to obtain the precipitates. Next, the precipitates were dried and extruded for the fabrication of nanocomposite filament. Diverse amounts of GO (0.5, 2, and 5 wt%) were mixed with polymer with a fixed ratio of TPU/PLA equal to 7:3. Thereby, a monolayer of the
as-prepared composite was printed on a glass substrate; then the live/dead viability/cytotoxicity assay using NIH3T3 mouse embryonic fibroblast cells was carried out. The experiment demonstrated that all scaffolds provided cell growth because they detected only live cells and not any dead cells in scaffolds. The maximum density of cells was reached in the scaffold with 0.5 wt% GO, Figure 11b [278].

![Figure 12.](image)

Figure 12. 96 h cell culture results of NIH3T3 cells on 3D printed TPU/PLA with different GO loadings: (a) 0 wt % GO, (b) 0.5 wt % GO, (c) 2 wt % GO, (d) 5 wt % GO. Green color indicates live cells, whereas red color indicates dead cells. Adapted with permission from [278]. Copyright (2017) American Chemical Society.

Foo et al. [282] developed a method for producing 3D printed electrode (3DEs) and its novel applications in electronic devices. Here, the 3DEs were created by employing a commercial graphene-based conductive filament that was purchased from Black Magic. Besides, a layer of gold was sputtered on the surface of the 3DEs for the complete fabrication of the electrode, which was named 3DE/Au, Figure 13 [282]. The 3DE/Au was used as the current collector and working electrode for a solid-state supercapacitor with a multilayered structure. Before the assembly of the supercapacitor, a layer of polypyrrole/reduced graphene oxide (Ppy/rGO) nanocomposites were deposited on the 3DE/Au surface via an in-situ electrochemical polymerization method. The assembled supercapacitor exhibited a good capacitance performance with a specific capacitance of 98.37 F/g. Also, these 3DEs were fabricated into a photoelectrochemical sensing platform that had a photocurrent response at ~724.1 µA and a lower detection limit (0.05 µM) compared with indium-doped tin oxide (ITO) or fluorine-doped tin oxide (FTO) glass electrode. Zhang et al. [281] manufacture by FDM highly conductive graphene flexible circuits. In this study, the authors used the modified two-step in-situ reduced method to synthesize the high conductive graphene, whose conductivity can reach to 600 S/cm. The first step was chemical reduction by 4-iodoaniline, while a thermal reduction at 1050 °C for 1 h under the argon atmosphere for the second step. After mixing rGO (6 wt%) and PLA homogeneously by melt intercalation, filaments of PLA-rGO composite were finally prepared and the conductivity was 4.76 S/cm. SEM images showed that graphene was well dispersed in the PLA substrate. The authors demonstrated that the orientation of r-GO fillers takes place during the extrusion process, and this effect contributes to the increase in the conductivity of the filaments. In addition, the 3D flexible circuits exhibit good bonding force between layers, indicating that the 3D structure can maintain the same good mechanical property in both the axial direction and transverse direction. Besides, the manufactured 2D flexible circuits on paper and polyimide (PI) substrates showed a great bonding force between the composite circuits and both substrates, Figure 14 [281].
Figure 13. Physiochemical characterization. (a) Optical image of 3D printing process, (b) 3D printed electrode used throughout study, (c) FESEM image of 3DE/Au electrode, and (d) corresponding magnified crosssectional area. Reproduced with permission from Ref. [282].

Figure 14. (a) Simplified schematics depicting the process of graphene-based 3D printing by FDM; (b) two units of 3D printed paper-based flexible circuits pattern; (c) LED circuit with a bunch of 3D printed filaments; (d) 3D printed flexible circuits. Reprinted from Publication [281], Copyright (2016), with permission from Elsevier.

3.2.4. Direct ink writing (DIW)

Direct ink writing is an AM technique based on the extrusion and deposition of a pseudo-plastic material (paste), which can maintain the shape of the extruded filament and the printed part in the time after extrusion. Previously, we had already considered this technique at the point 2.3.3 of the present work. The paste feedstock must have a high viscosity ($10^3$–$10^6$ mPa s, depending on the shear rate) and shear thinning behaviour (a decrease of viscosity with an increase of shear forces inside the nozzle) is essential for this technique [20, 154, 155].

Among all AM technologies, direct ink writing is one of the most broadly used for the manufacturing of 3D parts from a graphene-based feedstock [283] tanks to the combination of the great possibilities of DIW with the unique properties of graphene that has shown noteworthy printing capabilities and unique viscoelastic properties [29, 155, 281, 283-285].

Naficy et al. [286] reported that graphene-based pastes with concentration up to 13.3 mg/mL are suitable for DIW. In figure 15 [286] the storage and loss moduli of GO suspensions and the schematic illustrations of the proposed model for the evolution of liquid crystal (LC) phases in GO dispersions upon increasing concentration are showed. In this work, the storage modulus ($G'$) of GO at 13.3 mg/mL was measured and its value was found to be in the range of 350 to 490 Pa. These values considerably exceed the calculated elastic modulus value (~ 60 Pa) of a single-wall nanotube (SWNT) suspension with the same concentration. The rheological behaviour of LC GO dispersions are is shown in Figure 16 [286].
Figure 15. Storage and loss moduli (filled squares and open squares, respectively) of GO suspensions and the schematic illustrations of the proposed model for the evolution of LC phases in GO dispersions upon increasing concentration. (a) At this extremely low concentration. (b and c) Upon increasing the concentration to 0.25 mg/ml some nematic ordering starts to appear. (d) The dispersion forms a single phase nematic liquid crystal. (e) Further increase in concentration results in higher packing of the nematic phase. (f) In addition to long-range orientation in the nematic phase, some parts in GO exhibit long-range positional order. (g and h) Smaller monodomains are formed associated with exceptional increase in elastic modulus. Adapted from Ref. [286] with permission from The Royal Society of Chemistry.

Figure 16. Interpretation of rheological behaviour of LC GO dispersions. (a) Yield strain ($\gamma_Y$) and yield stress ($\sigma_Y$) of various GO suspensions with different GO concentration. (b) Storage and loss moduli of GO suspensions at the frequency of 0.01 Hz at different strains. (c) no aging after shear
rejuvenation/fluidization can be observed. Adapted from Ref. [286] with permission from The Royal Society of Chemistry.

In other work, Yao et al. [287] fabricated by DIW high-temperature and high rate heaters by using an aqueous paste with a high concentration of GO (80 mg/mL). The apparent viscosity of the paste falls in a range of 102 and 103 Pa·s (at a shear rate of 1 s⁻¹), while the storage modulus (G′) shows a plateau at 10⁴ Pa with shear stress in a range of 10⁻¹ Pa and 10² Pa. These values are essential for the layer-by-layer stacked architectures to have good shape retention. In the experiments, the prepared heaters generated high temperatures up to 3000 K in a controlled manner, while the temperature ramping response was fast and the heating rate was up to ~20,000 K/s. Moreover, 3D heaters also demonstrated excellent stability at high temperature and stable temperature switching between room temperature and 2000 K for more than 2000 cycles. Figure 17 shows schematic illustrations and pictures of the 3D printable heater.

Figure 17. Schematic demonstration of 3D printable heater. (a) 3D printing of RGO heater. Heaters with chamber size 1.5 mm are shown in the inset. (b) Photo image of as-printed horseshoe-like 3D heater. (c) The action of RGO heater at high temperatures is achieved by applying a driving current. (d) Photo image of 3D printed heater under high temperature operation. Adapted with permission from Ref. [287]. Copyright (2016) American Chemical Society.

In 2014, were first reported 3D-printed nanostructures composed entirely of graphene by Kim et al. [288]. In this work, a meniscus-guided growth method was adopted to write free-standing reduced graphene oxide (rGO) nanowires without any supporting materials by a micropipette. Due to the very small open diameter (1–2 µm) of the micropipette, the water would evaporate very fast which led to the solidifying of the GO suspension by pulling the micropipette. Thanks to the high control of moving various freestanding graphene structures could be printed with 100 nm resolution, ranging from straight wires, bridges, suspended junctions to woven structures [240].

Diverse studies about DIW of graphene-based materials with diverse applications, like as scaffold [283], Li-ion battery [153], and supercapacitor [155, 289] had been reported too. For example, Jakus et al. [290] fabricated multifunctional Microsystems by 3D printable graphene (3DG) composite for electronic and biomedical applications. In this study, graphene powder and polylactide-co-glycolide (PLG) were mixed in dichloromethane (DCM). During extrusion, rapid evaporation of DCM ensured a self-supporting filament that would not deform after deposition. The composites had a maximum graphene loading of 60 vol%. Additionally, the authors demonstrated that during the extrusion a flakes orientation occurs along with the filament microstructure. Graphene flakes aligned in the exterior of the filament but stacked within the filament.

Fu et al. [153] produced LiTi5O12 (LTO)/GO and LiFePO4 (LFP)/GO composites for the AM of Li-ion battery by DIW. The composites showed a high electrical conductivity after the thermal annealing of GO. Composite pastes were obtained by the addition of LFP or LTO to GO suspension (80 mg/mL) with a mass ratio of 7:3, in which only water was de solvent. The storage modulus (G′) of both pastes was in the region of 10⁴ to 10⁵ Pa during the plateau region, which indicated a stiffer ink with a solid-like response. On the other hand, yield stress values for the two composite pastes were 103 Pa. These two high values are necessary for the paste application in DIW. After the obtaining of electrodes were freeze-dried and then thermally annealed in Ar/H2 gas. The initial charge and discharge capacities of LFP/rGO electrode, at a specific current of 10 mA/g, were 168 and 164 mAh/g, respectively, that are very close values to the theoretical capacity of LFP (170 mAh/g); while LTO/rGO electrode showed values of 184 and 185 mAh/g, respectively, that are higher than the theoretical
capacity of LTO (175 mAh/g). On the other hand, the fabricated battery demonstrated initial charge
discharge capacities of 117 and 91 mAh/g at a specific current of 50 mA/g.

Liu et al. [289] studied the preparation of graphene oxide/polyaniline (PANI) feedstock for
flexible micro-supercapacitors (fMSCs). The authors made composite formulations by growing
vertically aligned pseudo-capacitive PANi nanorods on both sides of the GO surface. For this, the
first vertically attached PANi nanorods on the GO sheets using an interfacial polymerization
approach; and then, a GO/PANI composite with a well-defined nanostructure was obtained. Next,
the conductive poly(3,4-ethylenedioxythiophene): poly(styrenesulfonate) (PEDOT:PSS) was utilized
as a dispersing agent to achieve highly dispersed water-based GO/PANI-PEDOT:PSS (GO/PA-PE)
feedstock with suitable rheological properties for extrusion printing. Here, PANi nanorods were
wrapped by PEDOT:PSS changing their morphology from vertically aligned sharp protrusions to a
much smoother surface. The use of PEDOT:PSS not only improved the printability of the active
materials but also endowed the composition with high electrical conductivity and enabled the full
utilization of inner surface capacitance. The printed GO/PA-PE-based symmetric fMSCs exhibited
high areal capacitance (153.6 mF/cm² at 5 mV/s) and volumetric capacitance (19.2 F/cm³ at 5 mV/s)
which were higher or comparable to the literature values. Moreover, the authors demonstrated that
by fabricating asymmetric fMSCs using the GO/PANI as the positive electrode and a graphene-based
negative electrode, the voltage window can be widened from 0.8 to 1.2 V and improvements can be
achieved in energy density (from 3.36 to 4.83 mWh/cm³), power density (from 9.82 to 25.3 W/cm³),
and cycling stability (from 75% to 100% capacitance retention over 5000 cycles) compared with the
symmetric counterpart.

4. Direct ink writing technology of graphene-based ceramic pastes

As previously seen at the points 2.3.3 and 3.2.4 of this paper, direct ink writing holds great
promise for the production of parts based on both ceramic and graphene-based materials, mainly due
to versatility of DIW for the selection of materials and low-cost operation [20,26]. It was also indicated
that in the ceramic production the parts obtained by DIW can have low mechanical characteristics
due to the formed porous that appear during the elimination of additives and binders that were used.
As a possible solution to this problem, graphene-based materials were proposed to be used as filler
reinforce agents that, thanks to the unique properties of graphene, could improve the mechanical,
electrical and thermal properties of the ceramic composite [35].

DIW is one of the most widely applied AM technologies for the fabrication of 3D parts from a
graphene-based paste [29]. For obtaining a part with good properties by DIW a high graphene content
paste and with a suitable raw material is necessary [29,283-285]. Besides, a high colloid volume
fraction in the paste will minimize the drying-induced shrinkage after printing [29]. Very often, the
use of additives (binders, viscosifiers, among others) is needed to provide a good dispersion of the
graphene-based materials and obtain a paste with appropriate viscoelastic properties. In DIW the
paste viscosity for printing, which is related to the loss (i.e., viscous) modulus (G″), should be in the
order of 10^3–10^6 mPas, which are very high values. On the other hand, the storage (i.e., elastic)
modulus (G′) is associated with the paste elastic property thus, high values of G′ are required,
because the higher G′ the stiffer is the paste with a solid-like response [29]. When the ink exits the
nozzle, it will recover its yield stress and shear elastic modulus G′, thus maintaining its shape and
dimension [29].

In the state of the art of graphene-based/ceramic 3D printed composites by DIW, diverse works
with different applications as conductive ceramic nanocomposites [285,291], energy
storage/conversion systems, high-temperature filters, and others, can be found.

Roman-Manso et al. [291] first reported the study of 3D architected graphene/ceramic
composites obtained by DIW. These composites are applied in energy storage/conversion systems,
high-temperature filters or as catalyst supports, gas sensors, and acoustic metamaterials. These 3D
objects were printed starting from a paste containing homogeneous mixtures of SiC ceramic powders
and up to 20 vol% of graphene nanoplatelets (GNPs), and then, these objects were consolidated by
Spark Plasma Sintering (SPS). The paste was prepared as follows: three powder compositions were
formulated with diverse GNPs contents (5, 10 and 20 vol%). The ceramic powder was mainly composed of b-SiC and using Al₂O₃ and add Y₂O₃ as sintering aids, and holding the SiC:Al₂O₃:Y₂O₃ formulation constant at a 93:2:5 (wt%) ratio for all the compositions. To obtain a homogeneous powder composition, the aforementioned components were mixed in an attrition mill with alumina balls in an isopropyl alcohol media. At the same time, a stable dispersion of GNPs in isopropanol was prepared by sonication. Next, the ceramic combination and the nanoplatelets dispersion were mixed and, then, stirred and sonicated. Subsequently, the solvent was removed in a rotary evaporator, and the mixture was dried at 120 °C and sieved through a 63 μm mesh. With aim of preparing the pastes, well-dispersed suspensions of the as-obtained dried blend in an aqueous polymer solution of polyethylenimine (PEI), methylcellulose (MC) and ammonium polyacrylate (APA) were obtained in a planetary centrifugal mixer. In these suspensions, PEI, MC, and APA acted as a dispersant, viscosifying agent and flocculant, respectively. The aqueous polymer composition for pastes with contents up to 10 vol% of GNPs was (4 wt% of PEI, 5 wt% of MC and 0.3 wt% of APA); while the paste with 20 vol% needed a slight increase of the PEI content (5 wt%) to achieve the required pseudoplastic behavior. Note that in all cases, the solids content in the pastes was within the range of 69-71 wt% (42-44 vol%). Next, 3D architectured composites were manufactured using a DIW printer. After printing, the parts were heated up to 415 °C to burn out the organics and, then, the as-printed parts were sintered in an SPS furnace at 1800 °C and an Argon atmosphere. Sintered composites showed very-low-density values, ranging from 1.6 to 0.9 g/cm³ for corresponding GNPs contents of 0 to 20 vol%, as compared with theoretical values of the bulk compositions 3.28 g/cm³ for the monolithic SiC and 3.03 g/cm³ for the 20 vol% GNPs composites. Besides, the electrical conductivity of the scaffolds shows certain anisotropy with the structure orientation and increases with the GNPs volume fraction. In this way, values of up to 611 S/m for the longitudinal and 273 S/m for the transverse orientations of the structures relative to the extruded rods are achieved. This anisotropy was determined by the design of the structure and also by the strong preferential orientation of the GNP within the rod during the printing process.
Figure 18. (a) Patterned structure used for scaffolds designing and (b) scheme of the contact area between two orthogonal rods, where h, a, and Ø correspond to the distance between two equivalent layers in the z direction, the distance between two adjacent rods, and the rod diameter, respectively. (c) Apparent viscosity as a function of the shear rate for the GNP\textsubscript{s}/SiC pastes formulated with 0, 5, 10 and 20 vol\% GNP\textsubscript{s} in the powder compositions. d) View of a 10 vol\% GNP\textsubscript{s}/SiC sintered scaffold. Reprinted from Publication [291], Copyright (2016), with permission from Elsevier.

Tubio et al. [292] proposed a scalable fabrication of rGO/Al\textsubscript{2}O\textsubscript{3} composites with complex mesoscale architecture by DIW for their use in diverse applications. The paste production involved three basic steps: dispersion, mixing, and gelation. In the first step, an aqueous Al\textsubscript{2}O\textsubscript{3} colloidal suspension with different GO contents (0.5, 1 and 5 wt\%, based on Al\textsubscript{2}O\textsubscript{3} weight) was prepared in a planetary mixer. Then, the concentration of the as-prepared suspension was increased by water evaporation at room temperature and mixed again several times. Subsequently, hydroxypropyl methylcellulose (HPMC) was added to increase the viscosity followed by other mixed steps. Next, polyethyleneimine (PEI) was added to facilitate the gelation followed by other mixed steps. The rheological tests under steady and dynamic shear conditions were carried out to investigate the printability of as-prepared pastes. The data results showed two important effects: all pastes have shear-thinning (i.e., pseudoplastic) behaviour, and the GO content affects viscosity data in the whole shear-rate range. Moreover, the results showed that the paste with 5 wt\% GO content had the highest apparent viscosity and storage modulus (G\textsuperscript{'} \sim 1 \times 10\textsuperscript{6} Pa), while the shear yield stress raised to 220 Pa from 20 Pa for paste with 0 wt\% GO. Therefore, paste with 5 wt\% GO content was used for the fabrication of GO/Al\textsubscript{2}O\textsubscript{3} composites with complex mesoscale architecture by DIW. The obtained parts were sintered at 1600 °C in the N\textsubscript{2} atmosphere to form rGO-Al\textsubscript{2}O\textsubscript{3} composites.

In another work, Moyano et al. [293] proposed a new formulation of graphene-based pastes for producing self-supported 3D architectures by DIW. Here, the authors showed that is possible to use just a single surfactant for graphene-based pastes to achieve a suitable shear-thinning behavior and a high elastic modulus at rest. At the same time, the whole paste produce process is simple and scalable. Three aqueous graphene-based pastes were created by mixing GO, GNP and their mixture (GNP (92.7 wt\%) and GO (7.3 wt\%)) with an aqueous solution (30 wt\% concentration) of Poloxamer 407, a triblock copolymer that contains 70 wt\% of PEO units. Pastes with 30 wt\% solution of Poloxamer 407 display shear thinning characteristics. The G\textsuperscript{'} values of the three inks were 8 \times 10\textsuperscript{5} Pa, 4 \times 10\textsuperscript{5} Pa and 3 \times 10\textsuperscript{5} Pa for GNP, GO and their mix, respectively. These G\textsuperscript{'} values are comparatively larger than those previously reported for similar GO and GNP aqueous inks but prepared using different polyelectrolytes (anionic and cationic) [294]. The yield stress, which indicates the transition to a semi-liquid state in the inks, stays between 1 and 4 kPa. Subsequently, the as-prepared pastes were used for the printing of 3D structures. Next, structures were thermally treated at 1200 °C to reach an extraordinary compressive strength (above 2 MPa) for the light GO material (0.12 g/cm\textsuperscript{3}) and very high electrical conductivity (above 4 \times 10\textsuperscript{4} S/m) for the mix GO-GNP composition.
The previous examples showed that the classic production of graphene-based ceramic pastes involves the use of various polymers, which are later removed to get a composite of both ceramic and graphene-based materials. Different works have been carried out to develop new formulations and methods of paste preparation to reduce the number of additives in them.

One solution can be to modify the paste rheological behavior to reach suitable viscoelastic characteristics by adding some amount of silica. For example, Zhu et al. [155] investigated the method for manufacturing 3D graphene composite aerogel with periodic macropores for supercapacitor by DIW. Here, to prepare a suitable paste for DIW the GO suspension (40 mg/mL) was mixed with hydrophilic fumed silica. Silica acted as a viscosifier that imparted both shear-thinning behaviour and a shear yield stress to the GO suspension to enhance the printability of the GO-based paste. Besides, the authors added several graphene nanoplatelets (GNPs) along with a reactant (resorcinol-formaldehyde (R-F) solution) to induce gelation post-printing via organic sol-gel chemistry. GNPs and SiO$_2$ concentrations ranged from 0 to 16.7 wt% for both materials. The results demonstrated that the apparent viscosity of as-prepared composite paste (GO-GNP) shows orders of magnitude higher than that of the GO suspension; moreover, both of them were shear-thinning non-Newtonian fluids. Also, both the storage modulus and yield stress of pure GO ink increase by over one order of magnitude by the addition of the GNP and silica fillers [29]. The magnitudes of these key rheological parameters are in good agreement with those reported for other colloidal inks designed for DIW. After printing, the structure was then processed by gelation, freeze-drying or supercritical-drying, and etching of the silica with hydrofluoric acid, and the 3D graphene aerogel (GA) was finally fabricated [29]. Although in this work efforts were made to avoid the addition of polymer additives, the inclusion of silica did not completely solve this problem, since a reactant was still used for gelation of the paste.
Figure 20. Schematic diagram part fabrication process: Mixing of SiO$_2$, GNPs and R-F with the aqueous GO suspension. Then, the as-prepared GO paste was extruded in an isooctane bath, and the as-obtained part was gelled at 85 °C, then dried using supercritical carbon dioxide. Finally, the silica fillers were etched using diluted hydrofluoric acid. Scale bar is 10 mm. Reprinted with permission from [155]. Copyright (2016) American Chemical Society.

Another approach to preparing pastes with appropriate rheological properties for ceramic/graphene composites manufacturing by DIW could be the use of preceramic polymers (PCP) [295]. Preceramic polymers are polymeric compositions, especially in the form of organo-silicon compounds (e.g., polymers based on a backbone of Si atoms containing also C, O, N, B and H atoms), which by heat treatment (pyrolysis) above ~800 °C and under non-oxidative atmosphere (nitrogen or argon) are transformed into ceramic materials, also referred to as polymer derived ceramics (PDCs) [296]. The addition of PCPs into the graphene-based feedstock can modify the composition/phase, structures and properties of the final product after heat treatment [13].

Pierin et al. [297] reported a method for the manufacturing of micro-sized SiOC ceramic components by DIW using a preceramic polymer. The suitable rheological behavior of pastes was obtained by mixing cross-linked preceramic particles with a siloxane resin dissolved in a solvent. Moreover, the addition of a low amount (0.025–0.1 wt%) of GO to the paste formulation improves the structural stability during pyrolysis reducing the shrinkage of the preceramic polymer. The resulting parts after pyrolysis at 1000 °C showed good compression strength, of ~2.5 MPa for a total porosity of ~64 vol% (~3.1 MPa after the addition of 0.1 wt% graphene oxide).

Zhong et al. first developed GO/geopolymer (GOGP) nanocomposite structures fabricated by DIW, figure 21 [285]. The authors noted that the addition of GO in the geo-polymeric aqueous mixture (aluminosilicate and alkaline-source particles) intensely changes its rheology properties, and enable the DIW that cannot be realized solely by geo-polymer. Paste preparation involves the obtaining of geo-polymeric suspension by mixing of alkaline-source particles and aluminosilicates particles (ASOPs) in water. After stirring for 20 min, suspensions with diverse amounts of GO (4, 5, 10, and 20 wt%) were added into the as-prepared geo-polymeric suspension at a temperature below 5 °C. This low temperature avoids the geo-polymerization and the GO reduction that could happen at relatively elevated temperatures and would cause the agglomeration of nanoparticles. When GO is added into geo-polymeric suspension, the rheological behaviors of the mixture change dramatically.
For the GOGP with 4 wt% of GO the storage (\(G'\)) and loss modulus (\(G''\)) increased to \(~1 \times 10^5\) Pa and \(~1.5 \times 10^4\) Pa (at the stress of 50 Pa, that is typically used in DIW), which are more than one and two orders of magnitude higher than the corresponding values of pure geopolymer, respectively. Moreover, the shear yield stress is as high as \(~2000\) Pa. Upon increasing the GO load to 5 wt% of GO, storage modulus increased further, while the shear yield stress decrease to \(~1000\) Pa. However, for the nanocomposites with even higher GO loading (10, and 20 wt%), the modulus decreases, which is probably related to the lubrication effects of GO. The characterization of cured parts showed that GO nanosheets anchored themselves in geopolymer and encapsulated individual geopolymer grains, Figure 22 [285], to resist being pullout and at the same time, form a continuous 3D network throughout the whole nanocomposites. The as-obtained cured parts showed high mechanical properties (compressive strength > 30 MPa), while after sintering at 1000 °C the parts achieved a conductivity of \(10^2\) S/m.

**Figure 21.** (a-f) 3D printing process and some 3D printed structures. (b-f) The colors of the printed samples turn from brownish to blackish when the GO loading increased. (g) The chemical structure of geopolymer, and (h) schematic diagrams of the printing process and the composite structure are also showed. Reprinted from Publication [285]. Copyright (2017), with permission from Elsevier.
Figure 22. SEM images (a-d) and the corresponding models for the illustration of hydrated geopolymer particles encapsulation by GO layers. As the loading of GO in nanocomposite increased from 4 wt% to 20 wt%, the size of the particle agglomerate (marked by dotted-line circles) that encapsulated within GO films decrease. Reprinted from Publication [285], Copyright (2017), with permission from Elsevier.

In the state of the art of graphene-based ceramic 3D printed composites using preceramic polymers, interesting methods, which differ from the above examples in the way that ceramic phase is introduced in the 3D part, can be found. Commonly in these solutions, a 3D graphene-based part is first manufactured by DIW; then, it is heated for polymer removal followed by an infiltration step of a ceramic precursor [298-300].

Román-Manso et al. [298] developed an approach to manufacture PDC/GO composites. In this low-temperature method, the first 3D structures were fabricated by DIW using an aqueous GO paste with polymeric additives. After printing, the GO periodic structures were oven-dried at ~80 °C and immediately afterward frozen in a refrigerator at ~20 °C. This partial drying step helps eliminate water that would cause a network of evenly spaced cracks in the structures during freezing. Subsequently, the as-prepared GO structures were lyophilized to sublimate the ice. Finally, highly porous 3D structures were impregnated by immersion in a liquid organic-polysilazane (a compound of Si, C, H, N) during several hours to assure the penetration of the liquid within the structure rods. The impregnated scaffolds were held onto a Pt foil in alumina crucibles and treated in a tubular electric furnace at 200 °C for crosslinking and, afterward, pyrolysis at 800–1000 °C under a continuous N₂ flow during the whole cycle. Figure 23a displays an image of the as printed GO structure and the composite structure after the pyrolysis treatment (800 °C) evidencing the shape retention and the strong shrinkage experienced by the self-supported structure.

Figure 23b and c display top views of a lyophilized GO lattice at different magnifications. The quick-drying treatment, previous to the lyophilization, produced a linear shrinkage of the structures. Figure 23d-f show printed GO structures after the complete infiltration. No substantial cracking (Figure 23d and e) is detected in the infiltrated structures after pyrolysis (800–1000 °C). These PDC/GO composites imitate the patterned GO skeleton and, whereas the graphene network provides the conductive path for the composite (electrical conductivity in the range 0.2 – 4 S/cm). The ceramic coating serves as a protective barrier for the graphene network against the atmosphere, temperature (up to 900 °C in the air) and even direct flame.
Similar work was carried out by Moyano et al. [299], in which they studied the electrical, mechanical and capacitive responses of a strong and light 3D ceramic/graphene structure obtained through a controllable and fast infiltration method using a preceramic polymer.

Figure 23. (a) 3D printed scaffolds of GO (as-printed) and the composite structure GO/PSZ pyrolyzed at 800 °C. SEM micrographs of a GO lattice after dying/lyophilization steps showing a top view (b) and the surface of an extruded filament (c). Analogous SEM images of a PSZ infiltrated GO lattice pyrolyzed at 800 °C in N₂, (d) top view, (e) filament and (i) cross section at different magnifications. Reprinted from Publication [298], Copyright (2018), with permission from Elsevier.

Another interesting approach was reported by You et al. [300]. In this work, the authors proposed a method for the in-situ growth of SiC in 3D printed graphene scaffolds by chemical vapor infiltration (CVI). The scaffolds were fabricated using a well-dispersed graphene-based suspension, which was prepared by adding graphene to ethylene glycol butylether (EGB) in ethanol, followed by sonication and addition of dibutyl phthalate (DBP) and polyvinyl butyral (PVB). Next, the ethanol was evaporated in a water bath at 80 °C with continuous stirring. The as-prepared suspension had a graphene concentration of 200 mg/mL. After, the graphene scaffolds were printed using the as-prepared paste. Subsequently, the printed objects were placed in a carbon tube furnace under the Ar atmosphere and heated to 1100 °C for thermal decomposition of organic-polymer. The polymer decomposition allows a large specific surface area of the scaffold that is beneficial for promoting the in-situ growth and densification of the SiC. Thus, the SiC matrix was introduced into the pores of the 3D graphene scaffold by cracking methyltrichlorosilane (MTS) in the CVI process. The content and morphology of the SiC in the composite were controlled by adjusting the holding time and gas pressure, which are the main CVI parameters. Finally, the 3D graphene/SiC composites exhibit outstanding mechanical performance, delivering a maximum compressive strength of 193 ± 15.7 MPa, which is 394% higher than that of the directly mixed product. Besides, the combination of the 3D graphene scaffold and SiC matrix generates a larger number of conductive channels and provides a material that outperforms traditional ceramic materials in terms of electrical conductivity.

Unfortunately, in these last three examples, it is not possible to directly obtain a 3D printed part from which a graphene-based/ceramic composite is obtained after sintering. In these examples, an additional step of ceramic material infiltration into the graphene skeleton is necessary.

As we have seen in this section, each of the discussed methods includes a preparing step of the graphene-based paste that requires at least the presence of an additive, which is mainly utilized to guarantee a homogeneous dispersion and to achieve the suitable viscoelastic properties. In the majority of cases, the additives are eliminated either by a chemical etching or a thermal process at
high temperatures, which causes the appearance of pores in its structure that can negatively influence in the composite mechanical properties.

In recent years, attempts have been made to find new methods to minimize the presence of additives in graphene-based paste formulations for DIW. For example, García-Tuñón et al. [30] developed a clean, flexible and robust approach to formulating pastes used in DIW that can be adapted to a wide range of materials. Thus, they prepared free additive pastes of diverse materials (polymer, ceramic and metal), based only on the use of GO as the dispersant, rheological modifier, and binder. This procedure was possible to realize thanks to the great similarities between GO and clay. Both exhibit a flake-like shape with different functionalities on their edges and faces that result in the formation of particle networks connected by electrostatic interactions for clay and noncovalent interactions for GO. The unique structure and chemistry of clay permit the formulation of water-based suspensions with ideal viscoelastic behaviour for shaping. For this reason, clay is used as an additive in suspensions of other materials to provide the right viscoelastic behavior for processing. On the other hand, as for clay, the especial combination of GO sheets surface chemistry and structure in contact with water under special conditions allow the preparation of a very stable GO paste with proper viscoelastic behaviour for a wide range of materials with different chemistries, particle morphologies (from particles, platelets, and fibers to microspheres), and sizes (from nanometers to tens of micrometers). In this research, various kinds of graphene-based paste with ceramic (Al₂O₃ powders and platelets, SiC powders) were prepared and, then, used for the printing of ceramic parts. The increases of the paste concentration were reached by two different approaches: 1 - redispersing freeze-dried GO powders and 2 - by water evaporation in an oil bath at 70 °C. In both cases, concentrated GO pastes with good behavior for printing without the need of any other additive were obtained. Moreover, to tune viscoelasticity and flow, the additional freeze-dried powder was in some cases added to achieve the desired rheological behavior. In detail, the ceramic pastes reported in this work had the following concentrations: 1) 28.4 vol% SiC with 0.4 vol % GO (10 mg/mL), 2) 23 vol% Al₂O₃ platelets (0.8 vol % GO (23 mg/mL)) and 3) 27 vol% Al₂O₃ platelets (1.1 vol % GO (33 mg/mL).

The authors found that GO suspensions with a concentration above ~2 vol % lead to a rapid rise of the solid-like component (G', Figures 24a and b, [30]) due to the formation of a well-established and organized structure (Figure 24d, [30]). As the slurry becomes more concentrated, GO flakes arrange, forming a network, similar to a liquid crystal. The increase in concentration results in a considerable increase of the elastic response with storage modulus (G') values up to 100 kPa (for 3.5 vol % GO, Figure 24b, [30]) as well as an exponential increase of the yield stress up to 2300 Pa (Figure 24c, [30]). Besides, GO additive-free pastes with concentrations between ~2.5 and 3.5 vol % (prepared either by redispersing freeze-dried GO powders or by evaporation) displayed the rheological properties and structure needed for robocasting.
Figure 24. Viscoelastic properties for GO suspensions and pastes: fingerprints (a) and effect of GO concentration on $G'$ (storage modulus, b) and yield stress (c). The more concentrated systems are printable (labeled 3D-printable in “a”). Schematic showing the proposed assembly of GO flakes in water as concentration increases. (d) Some of the GO flakes roll up, forming graphene oxide scrolls; both assemble into a 3D liquid crystal structure with a strong elastic response “a”. Reprinted with permission from [30]. Copyright (2017) American Chemical Society.

For the Al$_2$O$_3$ platelets pastes, the best printing behavior was found for a mixture of ~28 vol % platelets with 1.1 vol % GO (Figure 25, [30]). Also, during extrusion an orientation of platelets and the formation of the internal architecture of the printed objects took place. Cross-sections and lateral views of printed filaments (Figures 25c and d respectively, [30]) show how the platelets arrange on the outside edge forming a wall, while the inside has a mixture of domains (Figures 25c and d respectively, [30]). After a close-up observation, GO flakes appear to have a strong interaction with the platelets, spreading over and across the surfaces of multiple Al$_2$O$_3$ platelets, binding them together and forming bridges across them. After sintering, the structures made with GO had an average porosity of 60% with only 2% closed pores and showed good handling strength.
Figure 25. Printing alumina platelets using GO as the only additive: (a and b) 3D printed objects (cylinders and micro pillars) and mesoscale FESEM images (c and d). (c) Cross section of the printed filaments showing domains with random orientation in the middle and (d) external arrangement of the platelets on the surface of the filament due to the extrusion process. Reprinted with permission from [30]. Copyright (2017) American Chemical Society.
Figure 26. Structural characterization at multiple scale lengths of a 3D printed cylinder made with an Al₂O₃ platelets/GO paste after sintering at 1550 °C. (a–c) Macroscopic images showing the external structure of the cylinder that preserves the morphological features of the printed filaments (side (a), angled (b), and top (c) views). The GO burn out results in a weight loss of ∼3 wt %. The bulk volume is subjected to a homogeneous shrinkage of ∼4% after sintering. (d and e) SEM images of the internal microstructure with open porosity of 60% calculated using an Archimedes kit. GO also enhances the sintering between platelets (d). Reprinted with permission from [30]. Copyright (2017) American Chemical Society.

The SiC paste also showed suitable printing behavior. Dried 3D printed bars had strengths of ~1 MPa, proving that GO is also acting as a binder of SiC surfaces. Sintered SiC bars (2050 °C for 2 h) have a final density of 3.21 g/cm³ (96.4% of the theoretical) and bending strengths of ~212 MPa.

In both cases, XRD analysis after sintering confirms that Al₂O₃ and SiC were the only crystalline phase, and no carbon bands were identified with Raman spectroscopy. Note that, GO can be either subsequently eliminated or retained during the postprocessing steps, thus potentially adding structural or functional properties to the final part.

Summarizing, this approach enables printing complex 3D ceramic structures using robocasting with similar properties to alternative formulations, thus demonstrating the potential of using 2D colloids in materials manufacturing.

5. Summary

In this review, it was shown that significant advances in additive technologies for 3D printing of graphene-based ceramic composites have been made in recent years. The state of the art of different additive techniques used for the manufacturing of both ceramic and graphene-based pieces was analyzed. In addition, various examples of 3D printing of graphene-based ceramic composites were discussed in detail.

First, a summary of existing additive technologies groups, techniques that are involved with them, and of the most popular feedstock nowadays was made, (see Table 1). After that, it was clear that not all AM technologies apply to the ceramic part manufacturing and even more for the graphene-based materials.

The introduction of Additive Manufacturing to the production of ceramics is related to the need to obtain complex structures that are impossible to realize using conventional methods since 3D printing can manufacture complex structures in a fast, simple and inexpensive way. With the aim of
a better understanding, the AM technologies used in ceramic production were divided into 3 groups (powder-, slurry – and bulk solid-based) taking into account the type of feedstock used. The state of the art of AM technologies that are involved with these groups has been discussed in detail and illustrated with representative examples. Moreover, several historical facts about each technique were given.

The techniques (SLS, SLM, and BJ.) are involved in the group of powder-based technologies for the manufacture of 3D ceramic parts. SLS and SLM have a low surface finish, undesirable porosity, and high shrinkage of parts that limit their application in many fields. Besides, the thermal gradients and the high heating and cooling rates in the ceramic material produce cracks and distortions that are not desired in the final part. On the other hand, in BJ the formation of pores and the contraction of parts are related to the elimination of the binder used in the process. In BJ the mechanical properties of parts are affected by pore formation, despite this, this technique is a good method used in biomedical fields for the ceramic scaffold production.

The liquid-based group includes the SLA, DLP, TPP and IJP techniques. These methods proved to be more promising than the powder-based ones as they can achieve high resolution, good surface finish and required mechanical properties. Unfortunately, the high cost of the machines and the photopolymers that are necessary for the manufacture of parts limit their wide application in the industry. Furthermore, the working principle of TPP allows only the use of transparent polymers; i.e. the opaque polymers that were usually utilized in SLA and DLP are not applicable for TPP. On the other hand, IJP is limited only to the production of miniaturized parts due to the low ink volume used in each droplet.

In the third group are LOM, FDM and DIW techniques. In recent years, great development of the LOM technique has not been observed and its application has been restricted only for the manufacture of ceramic parts with simple geometry, and large sizes. On the contrary, FDM and DIW have found a great application in the manufacture of macro-pore structures for the biomedicine application as the production of scaffolds.

AM techniques have also been used for 3D printing of graphene-based materials thanks to the combination of its properties with the advantages of slurry-based methods and techniques that use a pseudoplastic feedstock. Additionally, the choice of such technologies is related to the fact that graphene oxide, the main precursor of graphene, can be easily dispersed in water and other solvents, which is not possible with graphene. Among the most used methods for printing graphene-based material, we can find SLA, IJP, FDM, and DIW techniques.

The SLA method has been utilized to manufacture polymer-based composites that are used in the production of scaffolds in biomedicine. On the other hand, IJP is one of the most used techniques in the printing of graphene-based materials despite the low resolution and limitations that it presents. It is possible to found polymer-based filaments with graphene fillers for FDM that are used in the production of parts for biomedicine or in electronics and other areas of application. The disadvantage of this method is its low precision and the quality of the surface.

DIW is the most studied technique and one of the most widely used for the manufacture of 3D parts from a graphene-based feedstock thanks to the combination of the great possibilities of DIW with the unique properties of graphene that has demonstrated remarkable printing capabilities with unique viscoelastic properties. For DIW, the rheology of the suspension is very important, so it is essential to establish the appropriate content of the components to obtain their homogeneous dispersion. After the part is printed, a subsequent process is necessary for the removal of the solvent, which leads to the appearance of pores in the structure. Similar structures are widely used in the production of biomaterial scaffolds and energy storage fields.

Finally, a detailed study with some examples of printed composites from graphene-based ceramic pastes by DIW is carried out. In this field, there is a tendency to reduce the number of additives that are used for obtaining a homogeneous dispersion and very often produce undesired effects. Some examples show that it is possible the use preceramic polymers for the reduction of additives and to perform the characteristics of printed composites. Of great importance is the work carried out to create ceramic pastes without any other additives than graphene oxide. Here it is
appreciated how this material can be used as a dispersant, rheological modifier and binder at the same time.

This work has tried to show that the DIW method is very promising in the printing of complex graphene-based ceramic composites at reduced cost and in less time. We consider that this field should continue to develop so that soon the manufacture of graphene-based ceramic composites will take its place in the ceramic industry.


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